

High Performance Surface Mount Flip Chip LEDs

Technical Data

Features

- High Brightness AlInGaP Material
- Improved Reliability through Elimination of Internal Wire Bond
- -40 to 85°C Operating Temperature Range
- Three Small Package Sizes
- Industry Standard 2.0 x 1.25 mm and 1.6 x 0.8 mm Footprints
- Right Angle Package
- Three Colors Available
- Diffused Optics
- Compatible with IR and Through-the-wave Solder Processes
- Available in 8 mm Tape on 178 mm (7") and 330 mm (13") Diameter Reels

Applications

- Keypad Backlighting
- LCD Backlighting
- Symbol Backlighting
- Front Panel Indicator

Description

The HSMx-H670/H770, -H690/ H790, and -R661/R761 combine high reliability surface mount flip chip LED construction with HP's bright AlInGaP material. These very small, bright LEDs have a high luminous efficiency capable of producing high light output over a wide range of drive currents. The 590 nm amber, 605 nm orange, and 626 nm red colors are available in three compact, low profile packages.

The HSMx-H670/H770 has the industry standard $2.0 \ge 1.25$ mm footprint that is excellent for all around use. The HSMx-H690/



HP SunPower Series HSMA-H670/H690/H770/ H790/R661/R761 HSMC-H670/H690/H770/ H790/R661/R761 HSML-H670/H690/H770/ H790/R661/R761



H790 has the industry standard 1.6 x 0.8 mm footprint, and its low 0.6 mm profile and wide viewing angle make this LED excellent for backlighting applications.

The HSMx-R661/R761 has a small 2.1 x 1.3 mm footprint and a low profile 0.7 mm height that makes this part ideal for LCD backlighting and sidelighting applications where space is at a premium. All packages are compatible with IR and convective reflow soldering processes. In addition, these parts are also compatible with through-the-wave soldering processes.

Device Selection Guide

	Amber 590 nm		Orange 605	5 nm	Red 626 nm	
Footprint (mm) ^{[1][2]}	7" Reel	13" Reel	7" Reel	13" Reel	7" Reel	13" Reel
1.6 x 0.8 x 0.6	HSMA-H690	-H790	HSML-H690	-H790	HSMC-H690	-H790
2.0 x 1.25 x 1.1	HSMA-H670	-H770	HSML-H670	-H770	HSMC-H670	-H770
2.1 x 1.3 x 0.7 ^[3]	HSMA-R661	-R761	HSML-R661	-R761	HSMC-R661	-R761

Notes:

1. Dimensions in mm.

2. Tolerances \pm 0.1 mm unless otherwise noted.

3. Right angle package.

Package Dimensions



Absolute Maximum Ratings at $T_A = 25^{\circ}C$					
Parameter	Max. Rating	Units			
DC Forward Current ^[1]	20	mA			
Power Dissipation	50	mW			
Reverse Voltage	5	V			
$(I_{\rm R} = 100 \mu{\rm A})$					

-40 to 85

-40 to 85

Ab

Notes:

1. Derate linearly as shown in Figure 4 for temperatures above 25°C.

2. Maximum temperature for tape and reel packaging is 60°C.

Operating Temperature Range

Storage Temperature Range^[2]

Part No.	Color	Peak Wavelength λ _{peak} (nm) Typ.	Color, Dominant Wavelength $\lambda_d^{[2]}$ (nm) Typ.	Viewing Angle 20 ¹ / ₂ Degrees ^[3] Typ.	Luminous Efficacy η _v (lm/W)
HSMA-H6X0 HSMA-R661	Amber	592	590	165	480
HSML-H6X0 HSML-R661	Orange	607	605	165	370
HSMC-H6X0 HSMC-R661	Red	638	626	165	197

°C

°C

Optical Characteristics at T_A = 25 $^\circ\!C$

Optical Characteristics at $T_A = 25^{\circ}C$ (Cont'd)

		Luminous Intensity Iv (mcd) @ I _F = 5 mA		Luminous Intensity Iv (mcd) @ I _F = 20 mA	Luminous Intensity Iv (mcd) @ I _F = 2 mA
Part No.	Color	Min.	Тур.	Тур.	Тур.
HSMA-H6X0 HSMA-R661	Amber	2.5	7.5	35	2.5
HSML-H6X0 HSML-R661	Orange	2.5	7.5	35	2.5
HSMC-H6X0 HSMC-R661	Red	2.5	6.5	30	2.5

Notes:

1. The dominant wavelength λ_d is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.

2. $\theta^{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity.

3. Operation below $I_F = 1$ mA is not recommended.

		Forv Vol V _F (V @ I _F =	twardForwardltageVoltageVolts) V_F (Volts)= 5 mA@ I_F = 20 mA		Reverse Breakdown V _R (Volts) @ I _R = 100 μA	Capacitance C (pF) $V_F = 0$, f = 1 Mhz	
Part No.	Color	Тур.	Max.	Тур.	Max.	Min.	Тур.
HSMA-H670	Amber	1.9	2.2	2.0	2.4	5.0	20
HSMA-H690		1.9	2.2	2.0	2.4	5.0	20
HSMA-R661		1.9	2.2	2.0	2.4	5.0	20
HSML-H670	Orange	1.9	2.2	2.0	2.4	5.0	20
HSML-H690	_	1.9	2.2	2.0	2.4	5.0	20
HSML-R661		1.9	2.2	2.0	2.4	5.0	20
HSMC-H670	Red	1.8	2.2	1.9	2.4	5.0	20
HSMC-H690		1.8	2.2	1.9	2.4	5.0	20
HSMC-R661		1.8	2.2	1.9	2.4	5.0	20

Electrical Characteristics at $T_A = 25^{\circ}C$

Electrical Characteristics at $T_A = 25^{\circ}C$ (Cont'd)

		Thermal Resistance R	Thermal Resistance R
Part No.	Color	θ _{J-PIN} (°C/W)	θ_{J-A} (°C/W)
HSMA-H670	Amber	275	300
HSMA-H690		350	400
HSMA-R661		350	400
HSML-H670	Orange	275	300
HSML-H690	_	350	400
HSML-R661		350	400
HSMC-H670	Red	275	300
HSMC-H690		350	400
HSMC-R661		350	400



Figure 1. Relative Intensity vs. Wavelength.







Figure 2. Forward Current vs. Forward Voltage.

Figure 3. Relative Iv vs. DC Forward Current (operation below 1 mA not recommended).

Figure 4. Maximum DC Current vs. Ambient Temperature.



Figure 5. Intensity vs. Angle for HSMx-H670/H770 and HSMx-H690/H790.



Figure 6. Intensity vs. Angle (Horizontal) for HSMx-R661/R761.







HSMX-H690/H790 SERIES





HSMX-R661/R761 SERIES

1.0

0.8

Figure 8. Recommended Solder Pad Patterns.



Figure 9. Recommended IR Reflow Soldering Profile.



Figure 10. Recommended Wave Solder Profile.

6



Figure 11. Reeling Orientation.



Figure 12. Reel Dimensions.

7



Figure 13. Tape Dimensions, HSMx-H670/H770 Series.



Figure 14. Tape Leader and Trailer Dimensions for HSMx-H670/H770 Series.

8



Figure 15. Tape Dimensions, HSMx-H690/H790 Series.



Figure 16. Tape Leader and Trailer Dimensions for HSMx-H690/H790 Series.





Figure 17. Tape Dimensions for HSMx-RX61.



Figure 18. Tape Leader and Trailer Dimensions.

Convective IR Reflow Soldering

For more information on IR reflow soldering, refer to Application Note 1060, *Surface Mounting SMT LED Indicator Components*. www.hp.com/go/led

For technical assistance or the location of your nearest Hewlett-Packard sales office, distributor or representative call:

Americas/Canada: 1-800-235-0312 or 408-654-8675

Far East/Australasia: Call your local HP sales office.

Japan: (81 3) 3335-8152

Europe: Call your local HP sales office. Data subject to change. Copyright © 1999 Hewlett-Packard Co.

Obsoletes 5968-1097E (8/98) 5968-3197E (2/99)